



# 1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER PowerDI 123

#### **Features**

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- Lead Free Finish, RoHS Compliant (Note 4)
- " "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: PowerDI 123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (2)
- Marking & Type Code Information: See Last Page
- Weight: 0.01 grams (approx.)
- Ordering Information: See Last Page



TOP VIEW



BOTTOM VIEW

#### **Maximum Ratings** $@ T_A = 25^{\circ}C$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	14	V
Average Forward Current	I <sub>F(AV)</sub>	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1) @ $T_A = 25^{\circ}C$	PD	1.67	W
Power Dissipation (Note 2) @ $T_A = 25^{\circ}C$	PD	556	mW
Thermal Resistance Junction to Ambient (Note 1)	R ja	60	°C/W
Thermal Resistance Junction to Ambient (Note 2)	R <sub>JA</sub>	180	°C/W
Thermal Resistance Junction to Soldering (Note 3)	R <sub>JS</sub>	10	°C/W
Operating Temperature Range	Tj	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

Notes: 1. Part mounted on 50.8mm X 50.8mm GETEK board with 25.4mm X 25.4mm copper pad, 25% anode, 75% cathode.

2. Part mounted on FR-4 board with 1.8mm X 2.5mm cathode and 1.8mm X 1.2mm anode, 1 oz. copper pads.

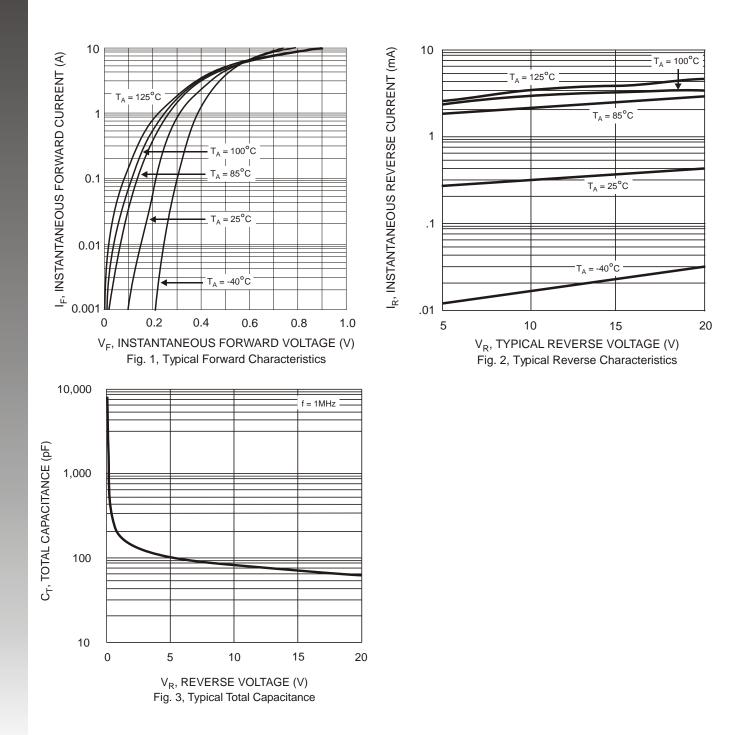
3. Theoretical R JS calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

4. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.



Electrical Characteristics @ T <sub>A</sub> = 25°C unless otherwise specified							
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
Reverse Breakdown Voltage (Note 5)	V <sub>(BR)R</sub>	20			V	I <sub>R</sub> = 1.0mA	
Forward Voltage	VF		0.20 0.30 0.32	0.36	V	$I_F = 0.1A$ $I_F = 0.7A$ $I_F = 1.0A$	
Leakage Current (Note 5)	I <sub>R</sub>		0.26	1.0	mA	$V_R = 5V, T_A = 25^{\circ}C$ $V_R = 20V, T_A = 25^{\circ}C$	
Total Capacitance	CT		75		pF	$V_{R} = 10V, f = 1.0MHz$	

Notes: 5. Short duration pulse test to minimize self-heating effect.



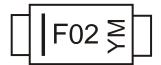


### Ordering Information (Note 6)

Device	Packaging	Shipping		
DFLS120L-7	PowerDI 123	3000/Tape & Reel		

Notes: 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

### **Marking Information**

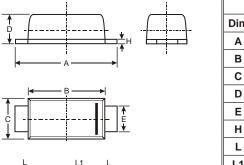


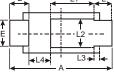
F02 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: P = 2003) M = Month (ex: 9 = September)

#### Date Code Key

Year	2003	3	2004	2005	2	006	20	07	200	8	200	9
Code	Р		R	S		Т	ι	J	V		W	
Month	Jan	Feb	March	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

## **Package Outline Dimensions**





PowerDI 123							
Dim	Min	Max	Тур				
Α	3.50	3.90	3.70				
В	2.60	3.00	2.80				
С	1.63	1.93	1.78				
D	0.93	1.00	0.98				
Е	0.85	1.25	1.00				
н	0.15	0.25	0.20				
L	0.45	0.85	0.65				
L1	_	_	1.35				
L2	_	_	1.10				
L3	_	_	0.20				
L4	0.90	1.30	1.05				
All Dimensions in mm							

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